

V <sub>DSS</sub>	650V
R <sub>DS(on)</sub> (Max.)	0.205Ω
Ι <sub>D</sub>	±20A
P <sub>D</sub>	231W

# ● Outline



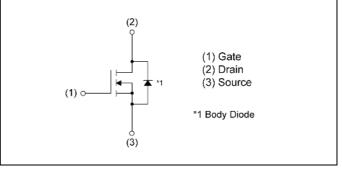
## Inner circuit



Application

Switching

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Parallel use is easy
- 4) Pb-free plating ; RoHS compliant



# Packaging specifications

Tube
C13
R6520KNZ4
600

# • Absolute maximum ratings ( $T_a = 25^{\circ}C$ ,unless otherwise specified)

Parameter	Symbol	Value	Unit	
Drain - Source voltage		V <sub>DSS</sub>	650	V
Continuous drain current $(T_c = 25)$	5°C)	۱ <sub>D</sub> *1	±20	А
Pulsed drain current		I <sub>DP</sub> *2	±60	А
Cata Cauraa valtara	static	N/	±20	V
Gate - Source voltage	AC(f>1Hz)	$V_{GSS}$	±30	V
Avalanche current, single pulse		I <sub>AS</sub>	3.4	А
Avalanche energy, single pulse		E <sub>AS</sub> *3	444	mJ
Power dissipation $(T_c = 25^{\circ}C)$	P <sub>D</sub>	231	W	
Junction temperature	Tj	150	°C	
Operating junction and storage te	T <sub>stg</sub>	-55 to +150	°C	

#### •Thermal resistance

Deremeter	Cumph of	Values			Lincit
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	$R_{thJC}^{*4}$	-	-	0.54	°C/W
Thermal resistance, junction - ambient	R <sub>thJA</sub>	-	-	30	°C/W
Soldering temperature, wavesoldering for 10s	T <sub>sold</sub>	-	-	265	°C

# •Electrical characteristics (T<sub>a</sub> = 25°C)

Parameter	Sumbol	Conditions	Values			- Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 1mA	650	-	-	V
		V <sub>DS</sub> = 650V, V <sub>GS</sub> = 0V				
Zero gate voltage drain current	I <sub>DSS</sub>	$T_j = 25^{\circ}C$	-	-	100	μA
		T <sub>j</sub> = 125°C	-	-	1000	
Gate - Source leakage current	I <sub>GSS</sub>	$V_{GS}$ = ±20V, $V_{DS}$ = 0V	-	-	±100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 630 \mu A$	3	-	5	V
		V <sub>GS</sub> = 10V, I <sub>D</sub> = 9.5A				
Static drain - source on - state resistance	$R_{DS(on)}^{*5}$	$T_j = 25^{\circ}C$	-	0.185	0.205	Ω
		$T_j = 125^{\circ}C$	-	-	-	
Gate resistance	R <sub>G</sub>	f = 1MHz, open drain	-	2.4	-	Ω



# •Electrical characteristics ( $T_a = 25^{\circ}C$ )

Deremeter	Curren el	Conditions	Values			Unit
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	1550	-	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 25V	-	1450	-	pF
Reverse transfer capacitance C <sub>rss</sub>		f = 1MHz	-	45	-	
Turn - on delay time	t <sub>d(on)</sub> *5	$V_{DD} \simeq 300$ V, $V_{GS}$ = 10V	-	30	-	
Rise time	t <sub>r</sub> *5	I <sub>D</sub> = 10A	-	50	-	12.0
Turn - off delay time $t_{d(off)}^{*5}$		$R_L \simeq 30\Omega$	-	75	-	ns
Fall time	t <sub>f</sub> *5	R <sub>G</sub> = 10Ω	-	30	-	

# • Gate charge characteristics (T<sub>a</sub> = 25°C)

Deremeter	Cyrrada a l	Conditions	Values			Unit
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit
Total gate charge	Q <sub>g</sub> *5	$V_{DD} \simeq 300V$	-	40	-	
Gate - Source charge	Q <sub>gs</sub> *5	I <sub>D</sub> = 20A	-	10	-	nC
Gate - Drain charge	Q <sub>gd</sub> *5	V <sub>GS</sub> = 10V	-	17	-	
Gate plateau voltage	V <sub>(plateau)</sub>	$V_{DD} \simeq 300$ V, I <sub>D</sub> = 20A	-	6.8	-	V

\*1 Limited only by maximum channel temperature allowed

- \*2 Pw  $\leq$  10µs, Duty cycle  $\leq$  1%
- \*3 L $\doteqdot$ 70mH, V<sub>DD</sub>=50V, R<sub>G</sub>=25 $\Omega$ , Starting T<sub>j</sub>=25°C

\*4 T<sub>C</sub>=25°C

\*5 Pulsed



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# •Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Source current	I <sub>S</sub> *1		-	-	20	A	
Pulsed source current	$I_{SP}^{*2}$	T <sub>C</sub> = 25°C	-	-	60	А	
Source-Drain voltage	$V_{SD}^{*5}$	V <sub>GS</sub> = 0V, I <sub>S</sub> = 20A	-	-	1.5	V	
Reverse recovery time	t <sub>rr</sub> *5		-	500	-	ns	
Reverse recovery charge	Q <sub>rr</sub> *5	<sup>*5</sup> I <sub>S</sub> = 20A di/dt = 100A/µs		8	-	μC	
Peak reverse recovery current	۱ <sub>.۳</sub> *5		-	32	-	A	





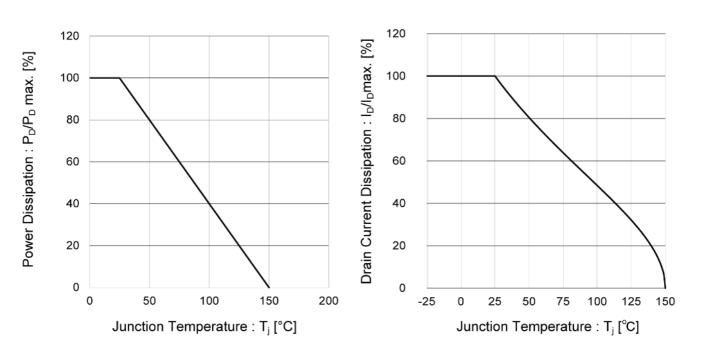


Fig.1 Power Dissipation Derating Curve

Fig.2 Drain Current Derating Curve

Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

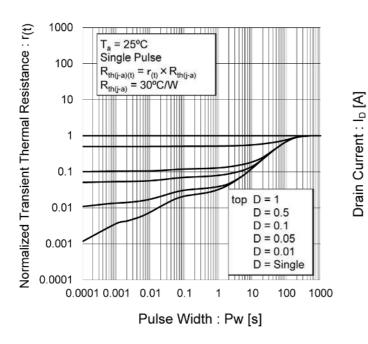
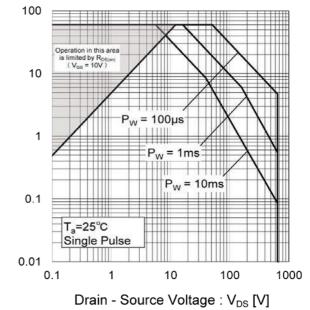
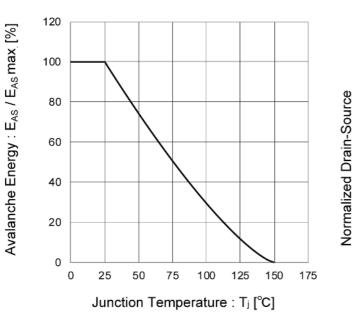


Fig.4 Maximum Safe Operating Area







# Fig.5 Avalanche Energy Derating Curve vs. Junction Temperature

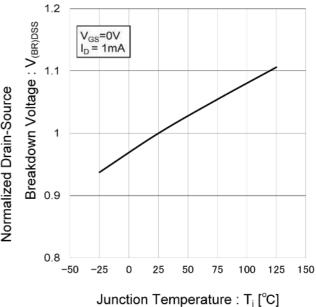
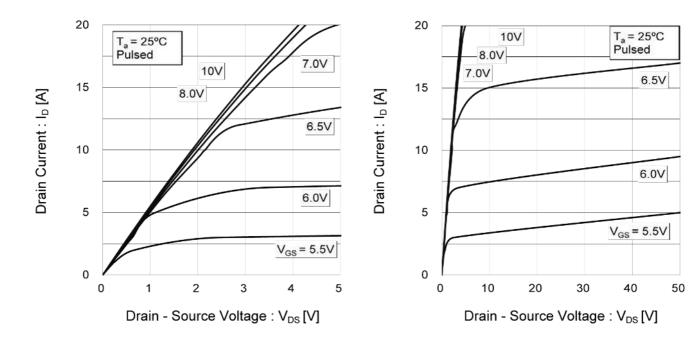


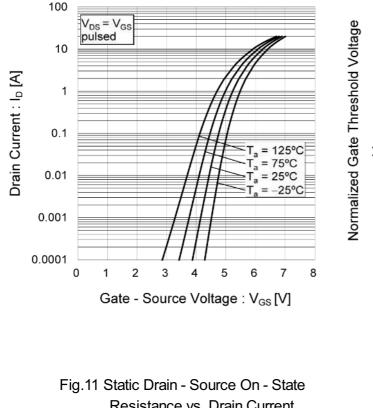
Fig.6 Normalized Breakdown Voltage vs. Junction Temperature

Fig.7 Typical Output Characteristics(I)

Fig.8 Typical Output Characteristics(II)

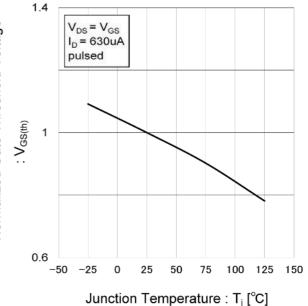






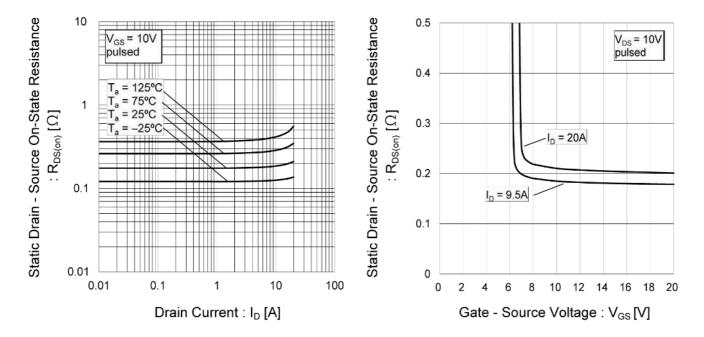
# Fig.9 Typical Transfer Characteristics

# Fig.10 Normalized Gate Threshold Voltage vs. Junction Temperature



Resistance vs. Drain Current

Fig.12 Static Drain - Source On - State Resistance vs. Gate - Source Voltage





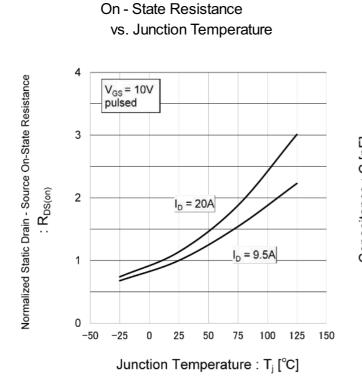
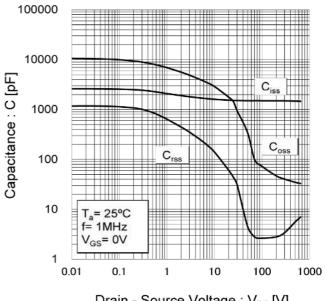


Fig.13 Normalized Static Drain - Source

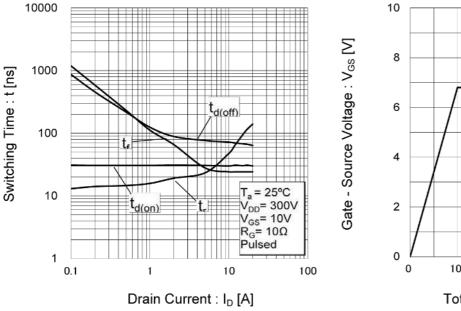
Fig.14 Typical Capacitance vs. Drain - Source Voltage

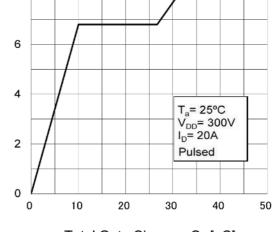


Drain - Source Voltage : V<sub>DS</sub> [V]

Fig.15 Switching Characteristics

Fig.16 Typical Gate Charge





Total Gate Charge : Qg [nC]



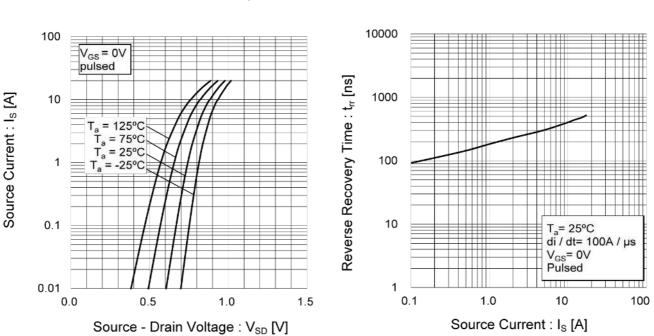


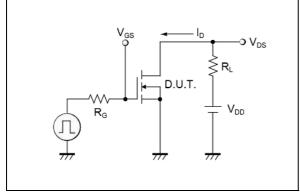
Fig.17 Source Current vs. Source - Drain Voltage Fig.18 Reverse Recovery Time vs. Source Current



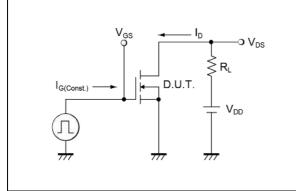


### Measurement circuits

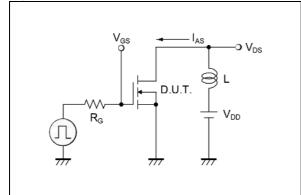
Fig.1-1 Switching Time Measurement Circuit



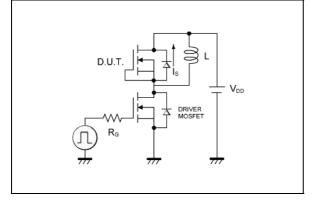
#### Fig.2-1 Gate Charge Measurement Circuit



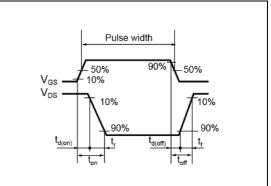
### Fig.3-1 Avalanche Measurement Circuit



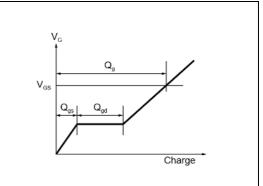
### Fig.4-1 trr Measurement Circuit



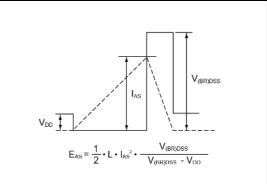
#### Fig.1-2 Switching Waveforms



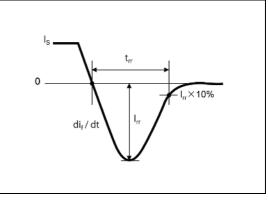
#### Fig.2-2 Gate Charge Waveform



### Fig.3-2 Avalanche Waveform

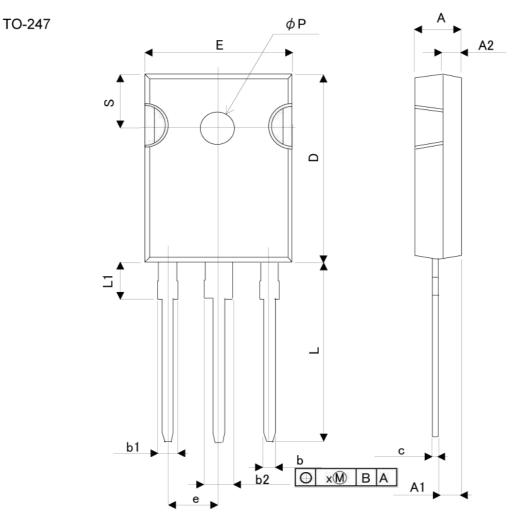


#### Fig.4-2 trr Waveform





## Dimensions



DIM	MILIM	ETERS	INC	HES
	MIN	MAX	MIN	MAX
A	4.82	5.22	0.190	0.206
A1	2.11	2.71	0.083	0.107
A2	1.80	2.20	0.071	0.087
b	1.00	1.40	0.039	0.055
b1	1.80	2.20	0.071	0.087
b2	2.80	3.20	0.110	0.126
с	0.45	0.75	0.018	0.030
D	20.65	21.25	0.813	0.837
E	15.64	16.24	0.616	0.639
е	5.4	44	0.2	14
L	19.77	20.37	0.778	0.802
L1	4.09	4.29	0.161	0.169
Р	3.51	3.71	0.138	0.146
S	5.97	6.37	0.235	0.251

Dimension in mm/inches



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CLASSⅣ	CLASSIII	CLASSⅢ	CLASSI

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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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